

**GJ35N03**

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BVDSS	25V
RDS(ON)	13.5mΩ
ID	36A

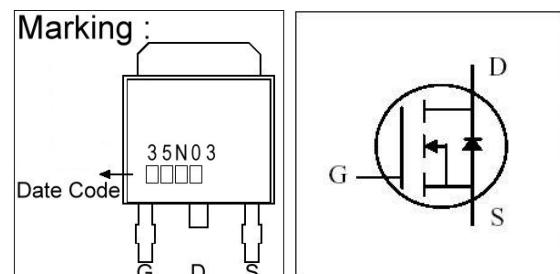
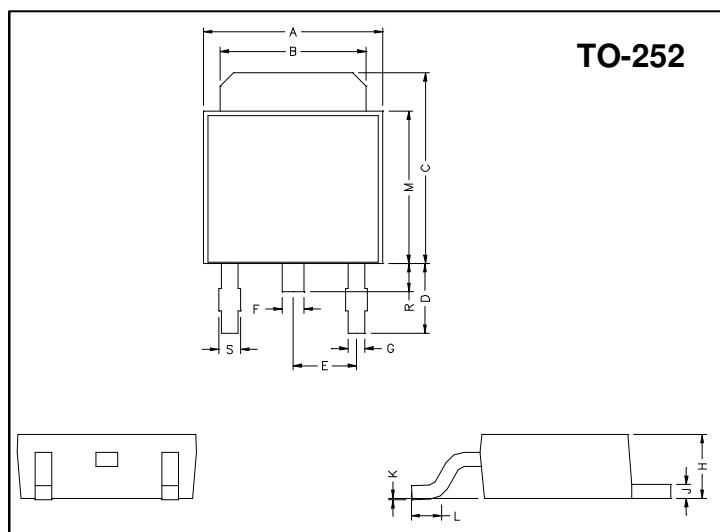
**Description**

The GJ35N03 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-252 package is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

**Features**

- \*Dynamic dv/dt Rating
- \*Simple Drive Requirement
- \*Repetitive Avalanche Rated
- \*Fast Switching

**Package Dimensions**

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	6.40	6.80	G	0.50	0.70
B	5.20	5.50	H	2.20	2.40
C	6.80	7.20	J	0.45	0.55
D	2.40	3.00	K	0	0.15
E	2.30	REF.	L	0.90	1.50
F	0.70	0.90	M	5.40	5.80
S	0.60	0.90	R	0.80	1.20

**Absolute Maximum Ratings**

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V <sub>DS</sub>	25	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> @10V	I <sub>D</sub> @T <sub>c</sub> =25°C	36	A
Continuous Drain Current, V <sub>GS</sub> @10V	I <sub>D</sub> @T <sub>c</sub> =100°C	25	A
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	150	A
Total Power Dissipation	P <sub>D</sub> @T <sub>c</sub> =25°C	50	W
Linear Derating Factor		0.4	W/°C
Single Pulse Avalanche Energy <sup>2</sup>	E <sub>AS</sub>	150	mJ
Single Pulse Avalanche Current	I <sub>AS</sub>	25	A
Operating Junction and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150	°C

**Thermal Data**

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-case Max.	R <sub>thj-c</sub>	2.5	°C/W
Thermal Resistance Junction-ambient Max.	R <sub>thj-a</sub>	110	°C/W

# GTM CORPORATION

ISSUED DATE :2006/08/16  
REVISED DATE :

## Electrical Characteristics ( $T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	25	-	-	V	$\text{V}_{\text{GS}}=0$ , $\text{I}_D=250\mu\text{A}$
Breakdown Voltage Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}} / \Delta T_j$	-	0.037	-	V/ $^\circ\text{C}$	Reference to $25^\circ\text{C}$ , $\text{I}_D=1\text{mA}$
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	1.0	-	3.0	V	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$ , $\text{I}_D=250\mu\text{A}$
Forward Transconductance	$\text{g}_{\text{fs}}$	-	26	-	S	$\text{V}_{\text{DS}}=10\text{V}$ , $\text{I}_D=18\text{A}$
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	-	-	$\pm 100$	nA	$\text{V}_{\text{GS}}= \pm 20\text{V}$
Drain-Source Leakage Current( $T_j=25^\circ\text{C}$ )	$\text{I}_{\text{DSS}}$	-	-	1	$\mu\text{A}$	$\text{V}_{\text{DS}}=25\text{V}$ , $\text{V}_{\text{GS}}=0$
Drain-Source Leakage Current( $T_j=150^\circ\text{C}$ )		-	-	25	$\mu\text{A}$	$\text{V}_{\text{DS}}=20\text{V}$ , $\text{V}_{\text{GS}}=0$
Static Drain-Source On-Resistance <sup>3</sup>	$\text{R}_{\text{DS}(\text{ON})}$	-	7	13.5	$\text{m}\Omega$	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=30\text{A}$
		-	13	20		$\text{V}_{\text{GS}}=4.5\text{V}$ , $\text{I}_D=30\text{A}$
Total Gate Charge <sup>3</sup>	$\text{Q}_g$	-	18.4	-	nC	$\text{I}_D=18\text{A}$ $\text{V}_{\text{DS}}=20\text{V}$ $\text{V}_{\text{GS}}=5\text{V}$
Gate-Source Charge	$\text{Q}_{\text{gs}}$	-	3.57	-		
Gate-Drain ("Miller") Change	$\text{Q}_{\text{gd}}$	-	2.9	-		
Turn-on Delay Time <sup>3</sup>	$\text{T}_{\text{d}(\text{on})}$	-	11.7	-	ns	$\text{V}_{\text{DS}}=15\text{V}$ $\text{I}_D=18\text{A}$ $\text{V}_{\text{GS}}=10\text{V}$ $\text{R}_G=3.3\Omega$ $\text{R}_D=0.83\Omega$
Rise Time	$\text{T}_r$	-	3.87	-		
Turn-off Delay Time	$\text{T}_{\text{d}(\text{off})}$	-	32.1	-		
Fall Time	$\text{T}_f$	-	5.4	-		
Input Capacitance	$\text{C}_{\text{iss}}$	-	1176	-	pF	$\text{V}_{\text{GS}}=0\text{V}$ $\text{V}_{\text{DS}}=25\text{V}$ $f=1.0\text{MHz}$
Output Capacitance	$\text{C}_{\text{oss}}$	-	268	-		
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$	-	142	-		

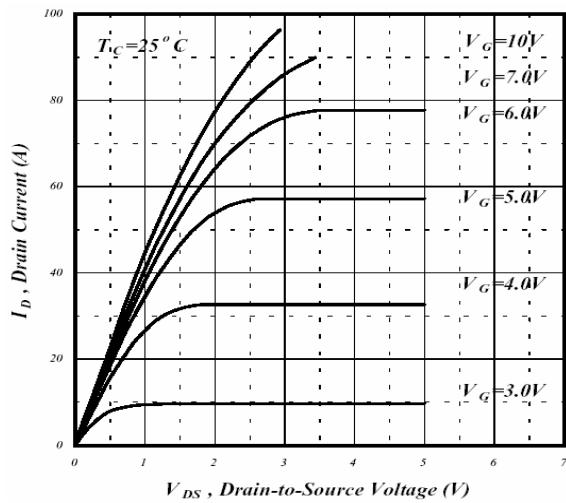
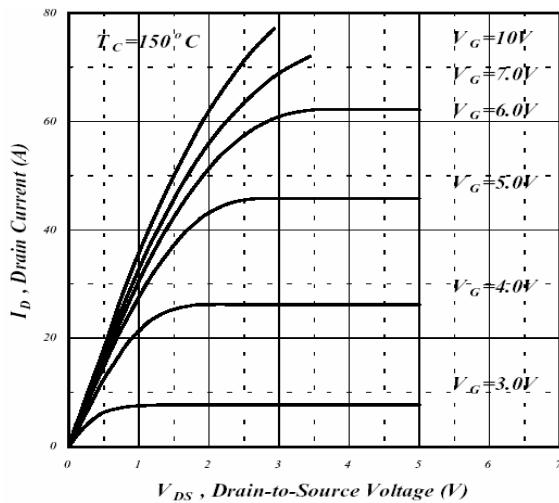
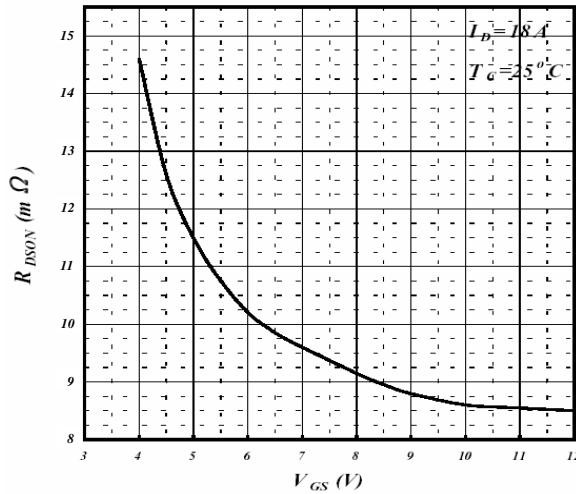
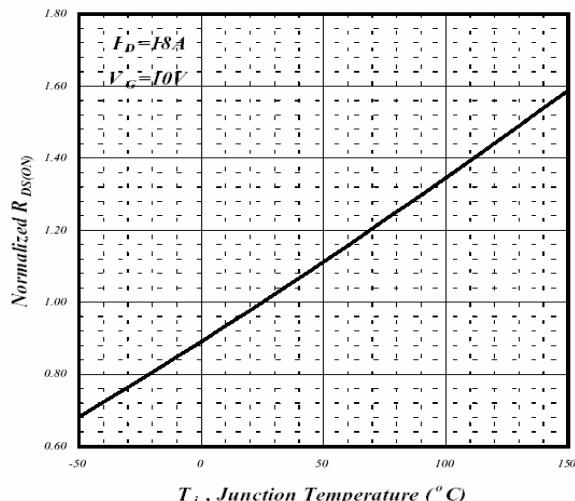
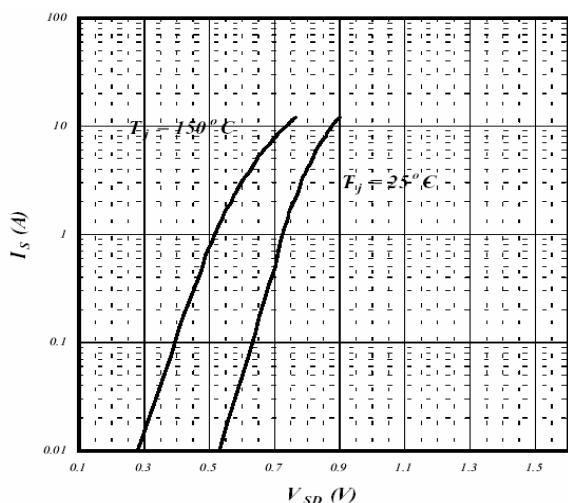
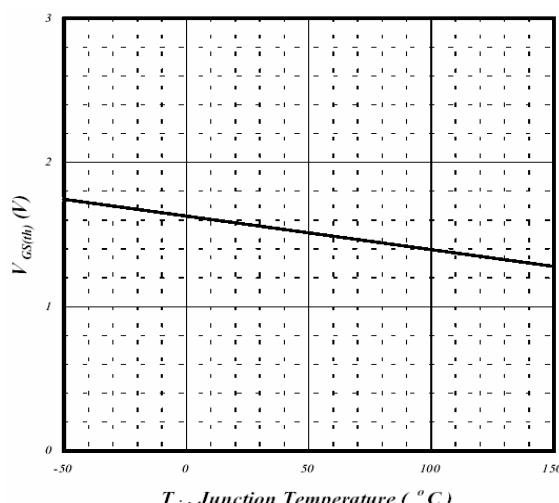
## Source-Drain Diode

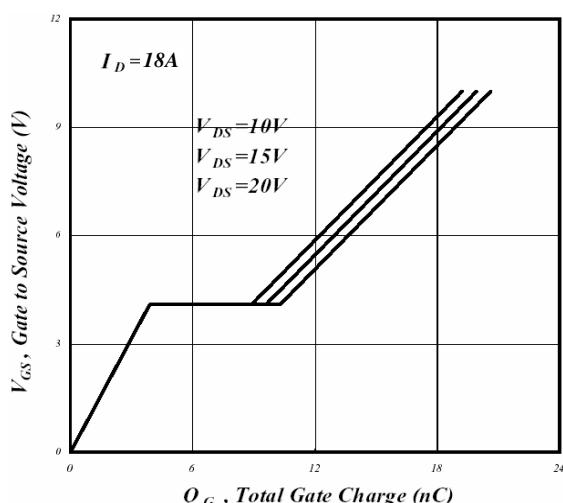
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage <sup>3</sup>	$\text{V}_{\text{SD}}$	-	-	1.5	V	$\text{I}_S=20\text{A}$ , $\text{V}_{\text{GS}}=0\text{V}$ , $T_j=25^\circ\text{C}$
Continuous Source Current (Body Diode)	$\text{I}_S$	-	-	50	A	$\text{V}_D= \text{V}_G=0\text{V}$ , $\text{V}_S=1.5\text{V}$

Notes: 1. Pulse width limited by safe operating area.

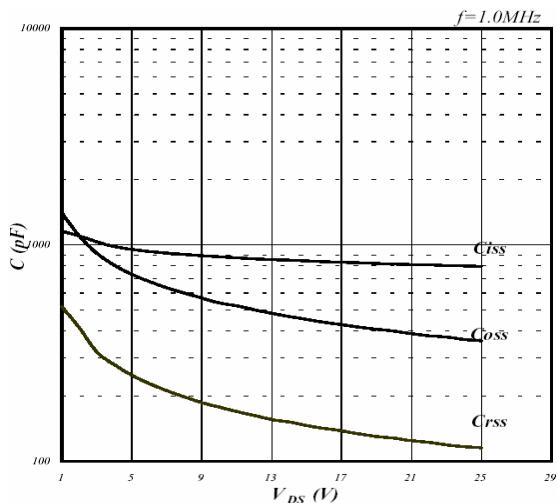
2. Staring  $T_j=25^\circ\text{C}$ ,  $\text{V}_{\text{DD}}=20\text{V}$ ,  $L=0.1\text{mH}$ ,  $\text{R}_G=25\Omega$ ,  $\text{I}_{\text{AS}}=10\text{A}$ .

3. Pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .

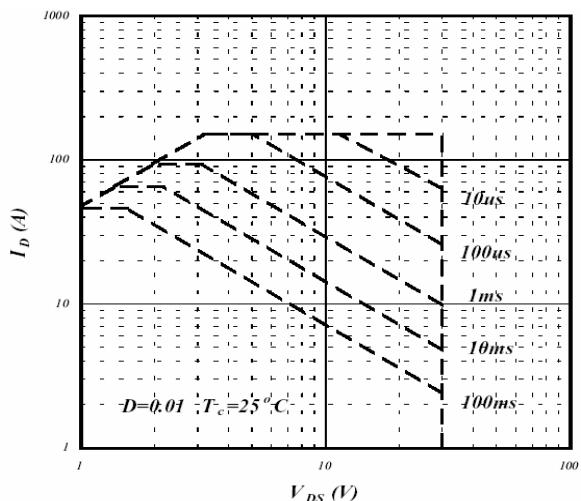
**Characteristics Curve****Fig 1. Typical Output Characteristics****Fig 2. Typical Output Characteristics****Fig 3. On-Resistance v.s. Gate Voltage****Fig 4. Normalized On-Resistance v.s. Junction Temperature****Fig 5. Forward Characteristics of Reverse Diode****Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



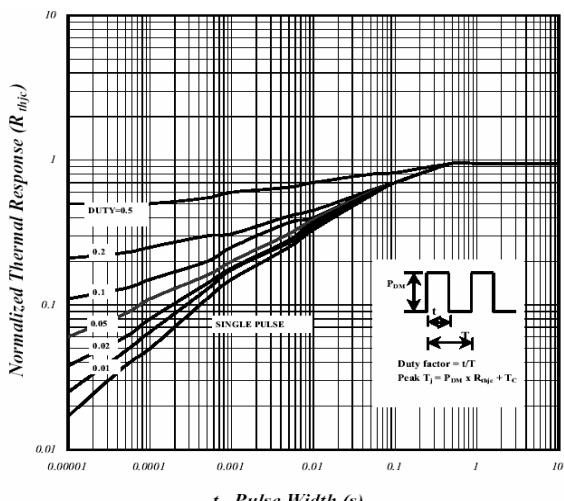
**Fig 7. Gate Charge Characteristics**



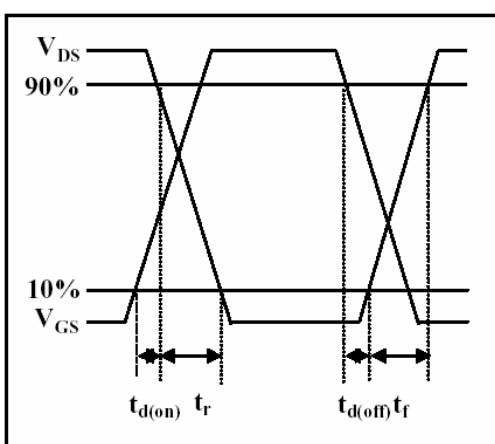
**Fig 8. Typical Capacitance Characteristics**



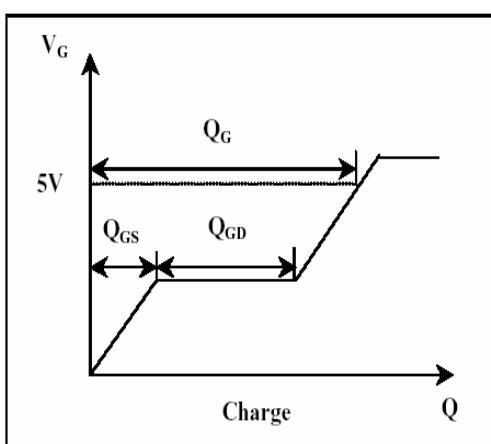
**Fig 9. Maximum Safe Operating Area**



**Fig 10. Effective Transient Thermal Impedance**



**Fig 11. Switching Time Waveform**



**Fig 12. Gate Charge Waveform**

**Important Notice:**

- All rights are reserved. Reproduction in whole or in part is prohibited without the prior written approval of GTM.
  - GTM reserves the right to make changes to its products without notice.
  - GTM semiconductor products are not warranted to be suitable for use in life-support Applications, or systems.
  - GTM assumes no liability for any consequence of customer product design, infringement of patents, or application assistance.
- Head Office And Factory:**
- **Taiwan:** No. 17-1 Tatung Rd. Fu Kou Hsin-Chu Industrial Park, Hsin-Chu, Taiwan, R. O. C.  
TEL : 886-3-597-7061 FAX : 886-3-597-9220, 597-0785
  - **China:** (201203) No.255, Jiang-Jiang Tsai-Lueng RD. , Pu-Dung-Hsin District, Shang-Hai City, China  
TEL : 86-21-5895-7671 ~ 4 FAX : 86-21-38950165